



| REV. | REVISIONS REC. | DATE | REV. | REVISIONS REC. | DATE |
|------|----------------------------|-----------|------|--|-----------|
| 1 | 端子材質硬度由:1/2H->H | '06.04.17 | 4 | (N1): 9.85->9.95; 且高壓側標記 4 處尺寸: 0.4->0.6 | '07.05.22 |
| 2 | 低壓側假PIN 處過線槽結構設變, 詳見標記 2 處 | '06.12.14 | | | |
| 3 | (N1): 9.70->9.85 | '07.04.09 | | | |

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|---|---------------|------------------------|-------------------------------------|--------------------------------|---------------------|
| DRAWN & DRAFTED BY HOU YI MIN | TOLERANCES | | ANGLE: ±1° | TITLE: UI-9.8-C SMD BOBBIN | |
| | ±0.1 | COPLANARITY 0.1 MAX | UNIT: MM | BOBBIN MATERIAL: LCP E4008 | UL REC. UL 94V-0 |
| CHECKED & APPROVED BY | ORIGIN: SZ | | PIN MATERIAL: PHOSPHOR BRONZE(H) | PIN TENSION LOAD: 2.0KG MIN | |
| PIN SHINE INDUSTRIAL CO., LTD. TEL: 886-2-22990545 FAX: 886-2-22990546 | | | DATE: JUN.16 '2005 | DRAWING NO. S-914-5 | REV. 4 |